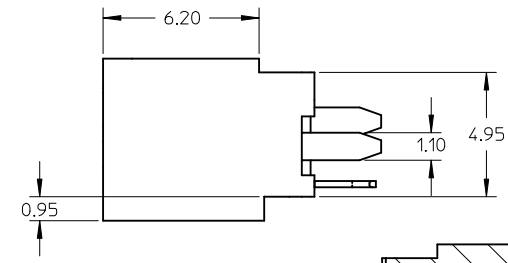
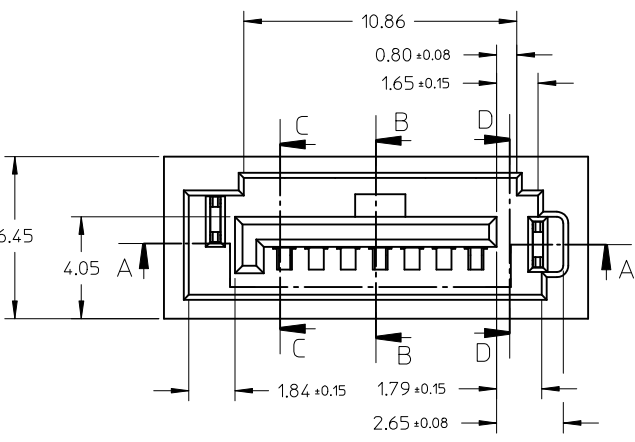


SECTION A-A

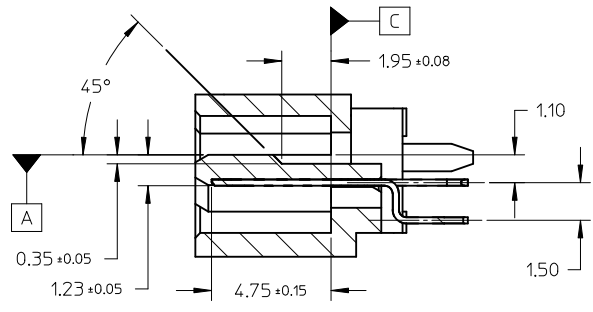
SECTION C-C



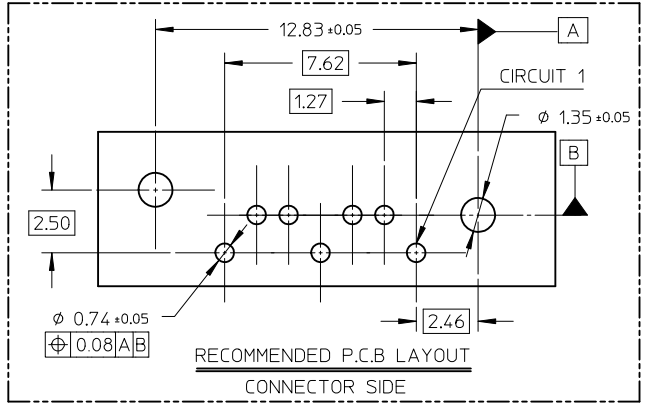
SECTION D-D



SECTION B-B



REMOVE PART NUMBER EC NO: SH2012-0062 DRWN: XQZHANG 2012/01/19 CHKD: XQZHANG 2012/01/30 APPR: AYIN 2012/02/02	QUALITY SYMBOLS $\nabla_{\text{A}}=0$ $\nabla_{\text{C}}=0$ $\nabla_{\text{F}}=0$	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		4 PLACES ± --- ± ---	mm INCH	DRAWN BY GRATE MA	DATE 2004/02/02	TITLE HIGH SPEED CONNECTOR 1.27MM PITCH VERTICAL DIP SOLDER TAIL				
		3 PLACES ± --- ± ---		CHECKED BY YAJUN	DATE 2004/02/02	MOLEX INCORPORATED				
		2 PLACES ± 0.15 ± --- 1 PLACE ± 0.25 ± ---		APPROVED BY SAM	DATE 2004/02/02	MATERIAL NO. SEE SHEET 2		DOCUMENT NO. SD-67800-007	SHEET NO. 1 OF 2	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		ANGULAR ±1/2°		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



- NOTES:
- MATERIAL:
 - HOUSING/COLOR: SEE TABLE, GLASS FILLED, UL94V-0
 - TERMINAL/PEG: BRASS
 - TERMINAL PLATING:
 - CONTACT AREA: (a) GOLD FLASH
 - (b) GOLD, THICKNESS=0.76 MICRON MINIMUM
 - (c) GOLD, THICKNESS=0.38 MICRON MINIMUM
 - SOLDER TAIL: TIN PLATED 1.27 MICRON MINIMUM OVER NICKEL PLATED 1.27 MICRON MINIMUM
 - PEG PLATING: TIN PLATED 1.27 MICRON MINIMUM OVER NICKEL PLATED 1.8 MICRON MINIMUM
 - PACKAGING SPECIFICATION: PK-67800-001
 - PRODUCT SPECIFICATION REFER TO PS-67491-001
 - RECOMMENDED SOLDERING PROCESS:
 - THERMAL PLASTIC FOR WAVE SOLDEING PROCESS
 - HIGH TEMPERATURE THERMAL PLASTIC FOR IR SOLDERING PROCESS

PART NUMBER	PLATING TYPE	DIM A	DIM B	P.C.B THICKNESS	PLASTIC TYPE	PLASTIC COLOR	REMARK
67800-7055	SEE NOTE2(c)						
67800-7052	SEE NOTE2(b)	2.85	3.05	2.00±0.05	THERMAL PLASTIC	NATURE	
67800-7051	SEE NOTE2(a)						
67800-7045	SEE NOTE2(c)	2.45	2.65	1.60±0.05			
67800-7042	SEE NOTE2(b)						
67800-7082	SEE NOTE2(b)	3.25	3.45	2.40±0.05			
67800-7075	SEE NOTE2(c)						
67800-7072	SEE NOTE2(b)	2.85	3.05	2.00±0.05	THERMAL PLASTIC	PROCESS BLUE C	
67800-7071	SEE NOTE2(a)					ΔE<3	
67800-7035	SEE NOTE2(c)	2.45	2.65	1.60±0.05			
67800-7031	SEE NOTE2(a)						
67800-7025	SEE NOTE2(c)						
67800-7022	SEE NOTE2(b)	3.25	3.45	2.40±0.05			PURE TIN
67800-7021	SEE NOTE2(a)						
67800-7015	SEE NOTE2(c)	2.85	3.05	2.00±0.05	THERMAL PLASTIC	BLACK	
67800-7011	SEE NOTE2(a)						
67800-7005	SEE NOTE2(c)						
67800-7002	SEE NOTE2(b)	2.45	2.65	1.60±0.05			
67800-7001	SEE NOTE2(a)						
67800-7115	SEE NOTE2(c)	2.85	3.05	2.00±0.05	HIGH TEMPERATURE	BLACK	
67800-7111	SEE NOTE2(a)						
67800-7105	SEE NOTE2(c)	2.45	2.65	1.60±0.05	THERMAL PLASTIC		
67800-7102	SEE NOTE2(b)						

SEE SHEET 1 EC NO: SH2012-0062 DRWN: XZZHANG 2012/01/19 CHKD: XZZHANG 2012/01/30 APPR: AYIN 2012/02/02	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
	$\nabla_{\text{A}} = 0$ $\nabla_{\text{B}} = 0$ $\nabla_{\text{C}} = 0$	mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.15 ± --- 1 PLACE ± 0.25 ± --- ANGULAR ± 1/2°	MM ONLY	5:1	METRIC	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DRAWN BY DATE	TITLE		
			CHECKED BY DATE	HIGH SPEED CONNECTOR 1.27MM PITCH VERTICAL DIP SOLDER TAIL		
		APPROVED BY DATE	MOLEX MOLEX INCORPORATED			
		MATERIAL NO.	SEE TABLE	DOCUMENT NO.	SD-67800-007	
		SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			SHEET NO. 2 OF 2